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FDS6898A

Dual N-Channel Logic Level PWM Optimized PowerTrench[®] MOSFET

General Description

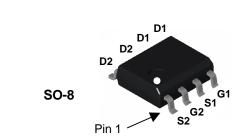
These N-Channel Logic Level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

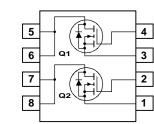
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

• 9.4 A, 20 V $\begin{array}{c} R_{\text{DS}(\text{ON})} = 14 \ \text{m}\Omega \ @ \ \text{V}_{\text{GS}} = 4.5 \ \text{V} \\ R_{\text{DS}(\text{ON})} = 18 \ \text{m}\Omega \ @ \ \text{V}_{\text{GS}} = 2.5 \ \text{V} \end{array}$

- Low gate charge (16 nC typical)
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Sour	ce Voltage	20	V		
V _{GSS}	Gate-Source Voltage			± 12	V	
I _D	Drain Curre	ent – Continuous	(Note 1a)	9.4	А	
		– Pulsed		38		
P _D	Power Dissipation for Dual Operation			2	W	
	Power Diss	ipation for Single Operati	ON (Note 1a)	1.6		
			(Note 1b)	1		
			(Note 1c)	0.9		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Therma	l Charac	teristics				
R _{eJA}	Thermal Resistance, Junction-to-Ambient		bient (Note 1a)	78	°C/W	
R _{eJC}	Thermal Resistance, Junction-to-Case		Se (Note 1)	40	°C/W	
Packag	e Markin	g and Ordering	Information			
Device Marking		Device	Reel Size	Tape width	Quantity	
FDS6898A		FDS6898A	13"	12mm	2500 units	

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Publication Order Number: FDS6898A/D

FDS6898A

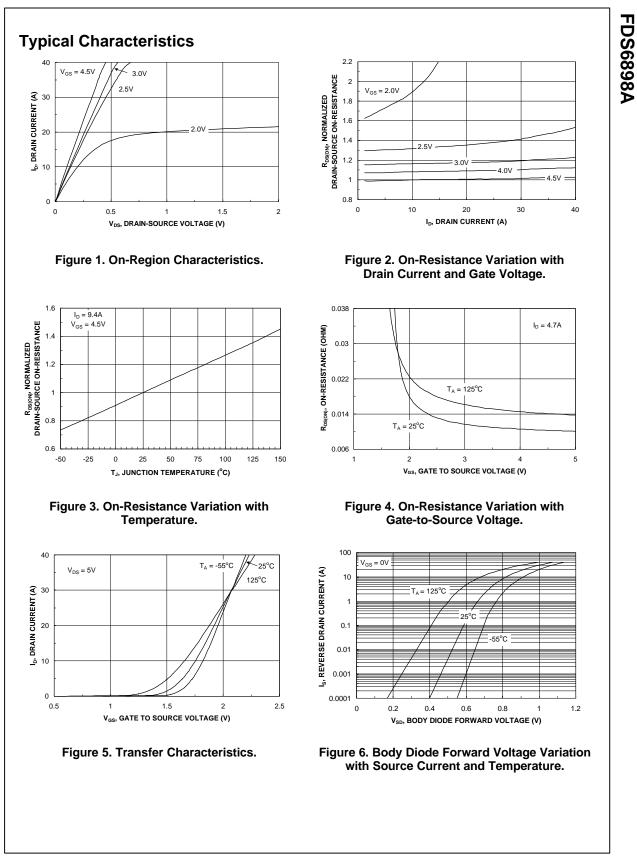
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	racteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		21		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 12 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -12 V, V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)		•		•	•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.5	1	1.5	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3.5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, \ I_D = 9.4 \ A \\ V_{GS} = 2.5 \ V, \ I_D = 8.3 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 9.4 \ A, T_J = 125^\circ C \end{array} $		10 13 14	14 18 21	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5V, \qquad V_{DS} = 5 V$	19			Α
g fs	Forward Transconductance	$V_{\text{DS}} = 5 \text{ V}, \qquad I_{\text{D}} = 9.4 \text{ A}$		47		S
Dynamic	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		1821		pF
Coss	Output Capacitance	f = 1.0 MHz		440		pF
C _{rss}	Reverse Transfer Capacitance			208		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V$, $I_D = 1 A$,		10	20	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		15	27	ns
t _{d(off)}	Turn–Off Delay Time			34	55	ns
t _f	Turn–Off Fall Time			16	29	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_{D} = 9.4 \text{ A},$		16	23	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 4.5 V		3	Ī	nC
Q _{gd}	Gate-Drain Charge	-		4		nC
Drain-S	ource Diode Characteristics a	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				1.3	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 1.3 A$ (Note 2)		0.7	1.2	V

Scale 1 : 1 on letter size paper

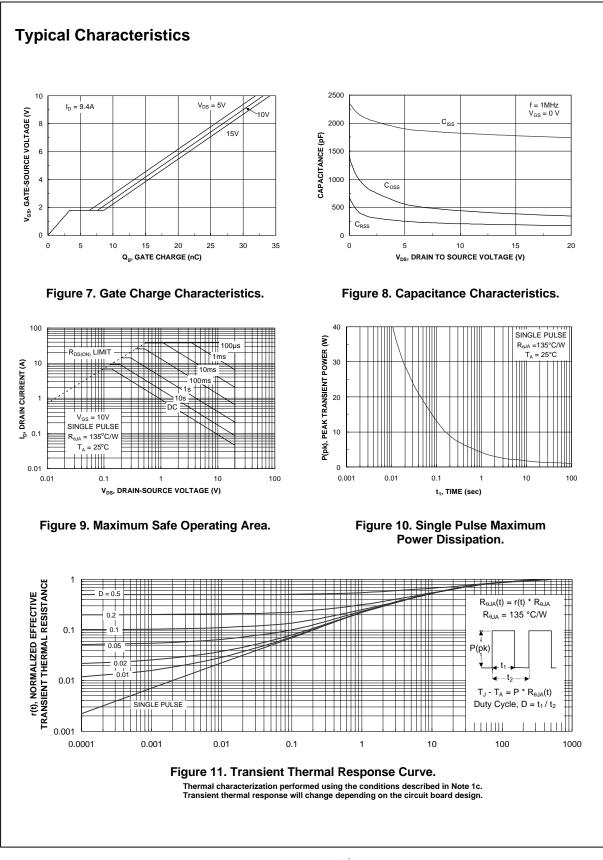
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied

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